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#### May 2015

#### FQD2P40

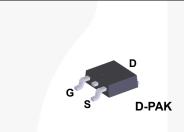
### P-Channel QFET<sup>®</sup> MOSFET -400 V, -1.56 A, 6.5 Ω

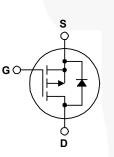
## Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance . Low Crss (Typ. 6.5 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.. • RoHS Compliant

#### Features

- -1.56 A, -400 V,  $R_{DS(on)}$  = 6.5  $\Omega$  (Max.) @ V<sub>GS</sub> = -10 V, I<sub>D</sub> = -0.78 A
- Low Gate Charge (Typ. 10 nC)
- 100% Avalanche Tested





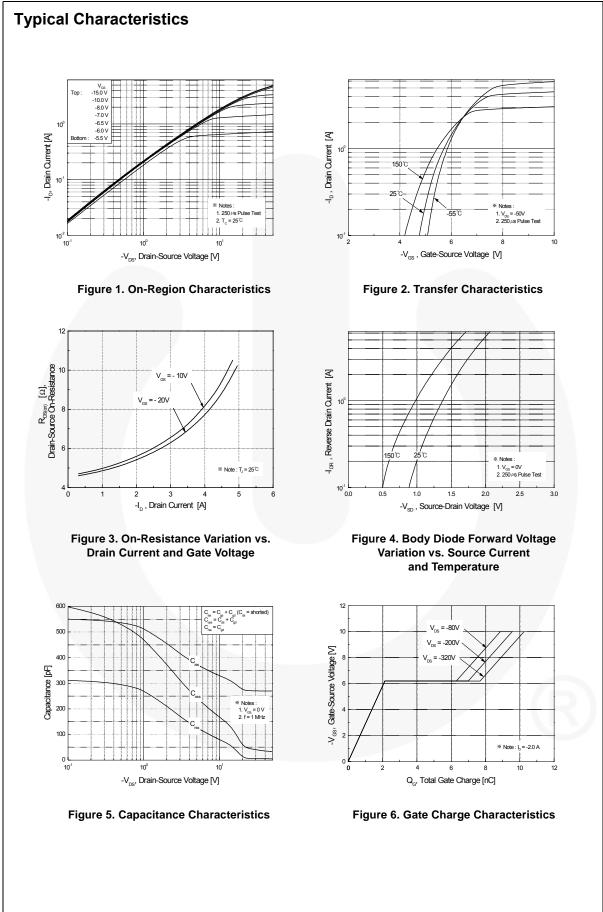
#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

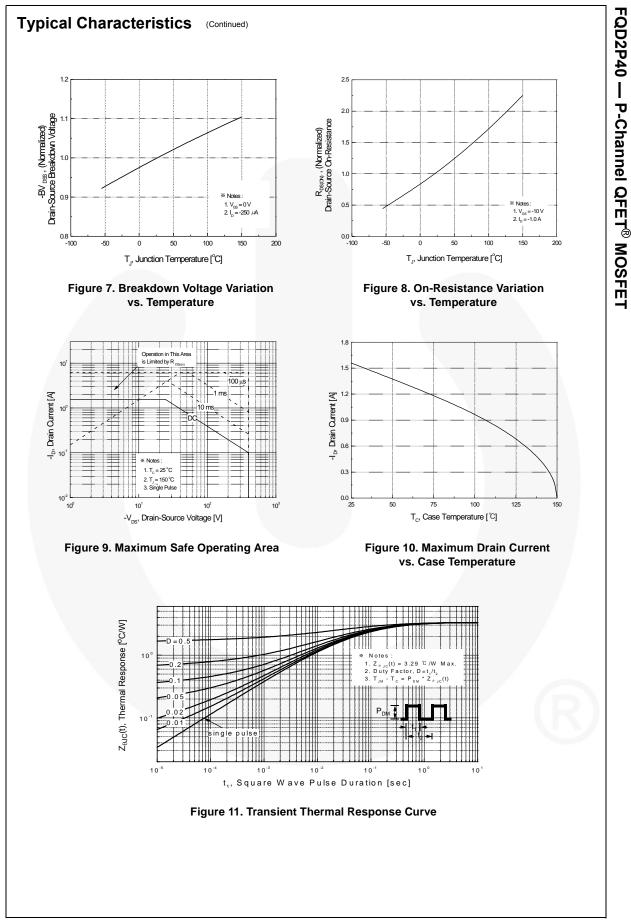
Symbol	Parameter		FQD2P40TM	Unit
V <sub>DSS</sub>	Drain-Source Voltage		-400	V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		-1.56	А
	- Continuous (T <sub>C</sub> = 100°C)		-0.98	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-6.24	A
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	120	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	-1.56	A
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	3.8	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> = 25°C) *		2.5	W
_	Power Dissipation ( $T_C = 25^{\circ}C$ )		38	W
	- Derate above 25°C		0.3	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		300	°C

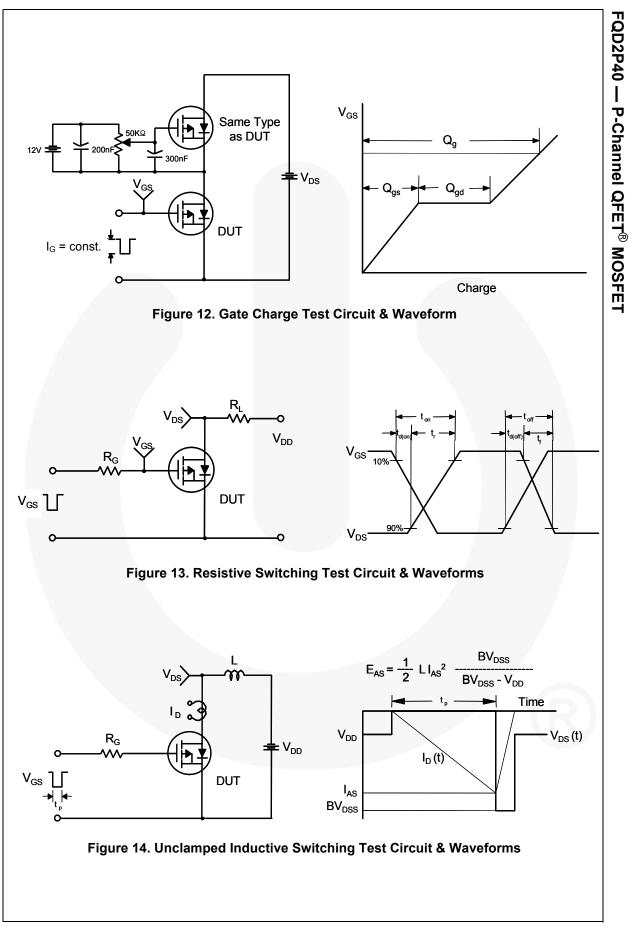
#### **Thermal Characteristics**

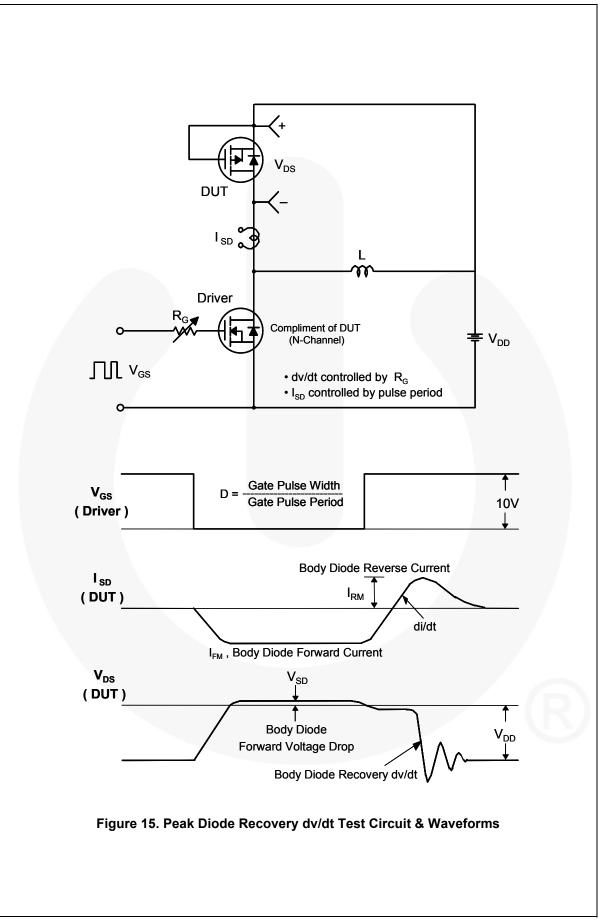
Symbol	Parameter	FQD2P40TM	Unit
$R_{\thetaJC}$	Thermal Resistance, Junction to Case, Max.	3.29	
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	50	

<b>racteristi</b> Drain-Sour Breakdowr Coefficient	ce Breakdown Volta	D-P T <sub>C</sub> = 25°C		Tape an	d Reel	330 ו	nm	16 mr	n	000
<b>racteristi</b> Drain-Sour Breakdowr Coefficient	Parameter CS rce Breakdown Volta	T <sub>C</sub> = 25°C	unless oth		PAK Tape and Reel 330			16 mm		2500 units
Drain-Sour Breakdowr Coefficient	<b>cs</b> ce Breakdown Volta			erwise noted.						
Drain-Sour Breakdowr Coefficient	<b>cs</b> ce Breakdown Volta			Test Cond	litions		Min.	Тур.	Max	. Unit
Drain-Sour Breakdowr Coefficient	ce Breakdown Volta							.,,,,,		
Breakdowr Coefficient		200	Voo =	0 V, I <sub>D</sub> = -25	ΟΠΑ		-400			V
	Breakdown Voltage Temperature		$I_D = -250 \mu\text{A}$ , Referenced to 25°C				-400	-		V/°C
Zero Gate			-	-400 V, V <sub>GS</sub>					-1	μΑ
	Voltage Drain Curre	ent		-320 V, T <sub>C</sub> =					-10	μΑ
Gate-Body	Leakage Current, F	orward	V <sub>GS</sub> =	-30 V, V <sub>DS</sub> =	• 0 V				-100	nA
	Leakage Current, F		V <sub>GS</sub> =	30 V, V <sub>DS</sub> =	0 V				100	nA
racteristi	cs									
			V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = -2	50 µA		-3.0		-5.0	V
								5.0	6.5	Ω
			V <sub>DS</sub> =	-50 V, I <sub>D</sub> = -0	).78 A			1.26		S
			1					270	250	
			20	00	: 0 V,					pF
			f = 1.0	MHz						pF pF
	,	_		-	-2.0 A,			9	30	ns
Turn Off D			$R_{c} = 2$					33	75	ns
Turn-On D	elay Time	-	R <sub>G</sub> = 2	.5 22				33 22	75 55	ns ns
Turn-Off Fa	,	_	. R <sub>G</sub> = 2	.5 22	(	Note 4)				
	all Time					Note 4)		22	55	ns
Turn-Off Fa	all Time Charge			-320 V, I <sub>D</sub> =		Note 4)		22 25	55 60	ns
Turn-Off Fa Total Gate	all Time Charge ce Charge		V <sub>DS</sub> =	-320 V, I <sub>D</sub> =	-2.0 A,	Note 4) Note 4)		22 25 10	55 60 13	ns ns nC
Turn-Off Fa Total Gate Gate-Sour Gate-Drain	all Time Charge ce Charge o Charge	stics ar	V <sub>DS</sub> = V <sub>GS</sub> =	-320 V, I <sub>D</sub> = -10 V	-2.0 A,			22 25 10 2.1	55 60 13 	ns ns nC nC
Turn-Off Fa Total Gate Gate-Sour Gate-Drain	all Time Charge ce Charge		V <sub>DS</sub> = V <sub>GS</sub> =	-320 V, I <sub>D</sub> = -10 V kimum Ra	-2.0 A,			22 25 10 2.1	55 60 13 	ns ns nC nC nC
Turn-Off Fa Total Gate Gate-Sour Gate-Drain	all Time Charge ce Charge charge charge	ource Dic	V <sub>DS</sub> = V <sub>GS</sub> = nd Max	-320 V, I <sub>D</sub> = -10 V <b>kimum Ra</b> rard Current	-2.0 A,			22 25 10 2.1 5.5	55 60 13  	ns ns nC nC nC
Turn-Off Fa Total Gate Gate-Sour Gate-Drair Ource Did Maximum Maximum	all Time Charge ce Charge n Charge ode Characteris Continuous Drain-S	ource Dic e Diode F	V <sub>DS</sub> = V <sub>GS</sub> = nd Max de Forw	-320 V, I <sub>D</sub> = -10 V <b>kimum Ra</b> rard Current	-2.0 A, tings			22 25 10 2.1 5.5	55 60 13  	ns ns nC nC nC
Turn-Off Fa Total Gate Gate-Sour Gate-Drain Ource Did Maximum Maximum Drain-Sour	all Time Charge ce Charge d Charge <b>ode Characteri</b> s Continuous Drain-S Pulsed Drain-Sourc	ource Dic e Diode F	$V_{DS} =$ $V_{GS} =$ <b>nd Max</b> de Forw forward $V_{GS} =$	-320 V, I <sub>D</sub> = -10 V <b>kimum Ra</b> rard Current Current	-2.0 A, htings		     	22 25 10 2.1 5.5	55 60 13   -1.56 -6.24	ns nC nC nC A A
	Gate Thres Static Drain On-Resista Forward Tr <b>c Charac</b> Input Capa Output Capa Reverse Tr <b>ng Chara</b> Turn-On D	racteristics Gate Threshold Voltage Static Drain-Source On-Resistance Forward Transconductance c Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time	Gate Threshold Voltage Static Drain-Source On-Resistance Forward Transconductance C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time	Gate Threshold Voltage       V <sub>DS</sub> =         Static Drain-Source       V <sub>GS</sub> =         On-Resistance       V <sub>DS</sub> =         Forward Transconductance       V <sub>DS</sub> = <b>c Characteristics</b> V <sub>DS</sub> =         Input Capacitance       V <sub>DS</sub> =         Output Capacitance       f = 1.0         Reverse Transfer Capacitance       V <sub>DD</sub> =         Turn-On Delay Time       V <sub>DD</sub> =	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = -2i$ Static Drain-Source On-Resistance $V_{GS} = -10 \text{ V}$ , $I_D = -4i$ Forward Transconductance $V_{DS} = -50 \text{ V}$ , $I_D = -6i$ Forward Transconductance $V_{DS} = -50 \text{ V}$ , $I_D = -6i$ C CharacteristicsInput CapacitanceOutput Capacitance $V_{DS} = -25 \text{ V}$ , $V_{GS} = -25 \text{ V}$ , $V_{GS} = -25 \text{ V}$ Reverse Transfer Capacitance $f = 1.0 \text{ MHz}$ ng CharacteristicsTurn-On Delay Time $V_{DD} = -200 \text{ V}$ , $I_D = -200 \text{ V}$ , $I_D = -200 \text{ V}$	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$ Static Drain-Source On-Resistance $V_{GS} = -10 \ V$ , $I_D = -0.78 \ A$ Forward Transconductance $V_{DS} = -50 \ V$ , $I_D = -0.78 \ A$ <b>c Characteristics</b> $V_{DS} = -50 \ V$ , $I_D = -0.78 \ A$ Input Capacitance $V_{DS} = -25 \ V$ , $V_{GS} = 0 \ V$ , f = 1.0 MHzReverse Transfer Capacitance $f = 1.0 \ MHz$ <b>num-On Delay Time</b> $V_{DD} = -200 \ V$ , $I_D = -2.0 \ A$ ,	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$ Static Drain-Source On-Resistance $V_{GS} = -10 \ V$ , $I_D = -0.78 \ A$ Forward Transconductance $V_{DS} = -50 \ V$ , $I_D = -0.78 \ A$ <b>c Characteristics</b> Input CapacitanceInput Capacitance $V_{DS} = -25 \ V$ , $V_{GS} = 0 \ V$ , f = 1.0 MHzReverse Transfer Capacitance $f = 1.0 \ MHz$ <b>ng Characteristics</b> Turn-On Delay TimeV_{DD} = -200 \ V, $I_D = -2.0 \ A$ ,	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$ -3.0Static Drain-Source On-Resistance $V_{GS} = -10 \ V$ , $I_D = -0.78 \ A$ Forward Transconductance $V_{DS} = -50 \ V$ , $I_D = -0.78 \ A$ <b>c Characteristics</b> $V_{DS} = -50 \ V$ , $I_D = -0.78 \ A$ Input Capacitance $V_{DS} = -25 \ V$ , $V_{GS} = 0 \ V$ , f = 1.0 MHzReverse Transfer Capacitance $r = -25 \ V$ , $V_{GS} = 0 \ V$ , f = 1.0 MHz <b>ng Characteristics</b> Turn-On Delay Time $V_{DD} = -200 \ V$ , $I_D = -2.0 \ A$ ,	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$ -3.0Static Drain-Source On-Resistance $V_{GS} = -10 \ V$ , $I_D = -0.78 \ A$ 5.0Forward Transconductance $V_{DS} = -50 \ V$ , $I_D = -0.78 \ A$ 1.26C CharacteristicsInput Capacitance $V_{DS} = -25 \ V$ , $V_{GS} = 0 \ V$ , f = 1.0 MHz270Output Capacitance $F = 1.0 \ MHz$ 6.5Input CapacitanceInput CapacitanceP and the second sec	Gate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$ 3.05.0Static Drain-Source On-Resistance $V_{GS} = -10 \ V$ , $I_D = -0.78 \ A$ 5.06.5Forward Transconductance $V_{DS} = -50 \ V$ , $I_D = -0.78 \ A$ 1.26c CharacteristicsInput Capacitance $V_{DS} = -25 \ V$ , $V_{GS} = 0 \ V$ , f = 1.0 MHz270350Output Capacitancef = 1.0 \ MHz4560Reverse Transfer CapacitanceTurn-On Delay Time











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